

## STGP7NC60H - STGD7NC60H

# N-CHANNEL 14A - 600V TO-220/DPAK Very Fast PowerMESH™ IGBT

**Table 1: General Features** 

| TYPE         | V <sub>CES</sub> | V <sub>CE(sat)</sub> (Max)<br>@25°C | <b>lc</b><br>@100°C |
|--------------|------------------|-------------------------------------|---------------------|
| STGP7NC60H   | 600 V            | < 2.5 V                             | 14 A                |
| STGD7NC60HT4 | 600 V            | < 2.5 V                             | 14 A                |

- LOWER ON-VOLTAGE DROP (Vcesat)
- OFF LOSSES INCLUDE TAIL CURRENT
- LOWER C<sub>RES</sub>/C<sub>IES</sub> RATIO
- HIGH FREQUENCY OPERATION UP TO 70 KHz
- NEW GENERATION PRODUCTS WITH TIGHTER PARAMETER DISTRIBUTION

#### **DESCRIPTION**

Using the latest high voltage technology based on a patented strip layout, STMicroelectronics has designed an advanced family of IGBTs, the PowerMESH™ IGBTs, with outstanding performances. The suffix "H" identifies a family optimized for high frequency applications in order to achieve very high switching performances (reduced tfall) mantaining a low voltage drop.

#### **APPLICATIONS**

- HIGH FREQUENCY INVERTERS
- SMPS AND PFC IN BOTH HARD SWITCH AND RESONANT TOPOLOGIES
- MOTOR DRIVERS

Figure 1: Package

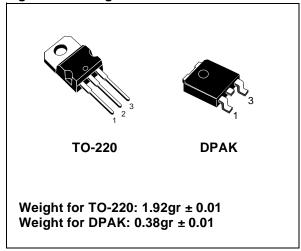


Figure 2: Internal Schematic Diagram

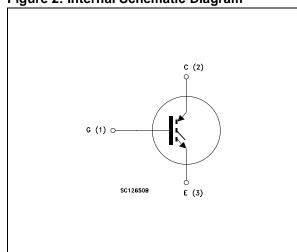


Table 2: Order Code

| PART NUMBER  | MARKING  | PACKAGE | PACKAGING   |
|--------------|----------|---------|-------------|
| STGP7NC60H   | GP7NC60H | TO-220  | TUBE        |
| STGD7NC60HT4 | D7NC60H  | DPAK    | TAPE & REEL |

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**Table 3: Absolute Maximum ratings** 

| Symbol              | Parameter  | Va          | lue  | Unit |
|---------------------|--|-------------|------|------|
|                     |  | TO-220      | DPAK |      |
| V <sub>CES</sub>    | Collector-Emitter Voltage (V <sub>GS</sub> = 0)              | 60          | 00   | V    |
| V <sub>ECR</sub>    | Emitter-Collector Voltage                                    | 2           | 20   | V    |
| $V_{GE}$            | Gate-Emitter Voltage   | ±           | 20   | V    |
| Ic                  | Collector Current (continuous) at T <sub>C</sub> = 25°C (#)  | 2           | Α    |      |
| Ic                  | Collector Current (continuous) at T <sub>C</sub> = 100°C (#) | 1           | 4    | Α    |
| I <sub>CM</sub> (⋈) | Collector Current (pulsed)                                   | 5           | 60   | А    |
| P <sub>TOT</sub>    | Total Dissipation at T <sub>C</sub> = 25°C                   | 80          | 70   | W    |
|                     | Derating Factor  | 0.64 0.56   |      | W/°C |
| T <sub>stg</sub>    | Storage Temperature  | 55 to 150   |      | °C   |
| Tj                  | Operating Junction Temperature                               | - 55 to 150 |      |      |

<sup>(</sup>E) Pulse width limited by max. junction temperature.

**Table 4: Thermal Data** 

|           |   |        | Min. | Тур. | Max. |      |
|-----------|---|--------|------|------|------|------|
| Rthj-case | Thermal Resistance Junction-case        | TO-220 |      |      | 1.56 | °C/W |
|           |   | DPAK   |      |      | 1.78 | C/VV |
| Rthj-amb  | Thermal Resistance Junction-ambient     | TO-220 |      |      | 62.5 | °C/W |
|           |   | DPAK   |      |      | 100  | C/VV |
| TL        | Maximum Lead Temperature for Soldering  | TO-220 |      | 300  |      | °C   |
|           | Purpose (1.6 mm from case, for 10 sec.) | DPAK   |      | 275  |      | C    |

## **ELECTRICAL CHARACTERISTICS** (T<sub>CASE</sub> =25°C UNLESS OTHERWISE SPECIFIED)

**Table 5: Main Parameters** 

| Symbol               | Parameter   | Test Conditions  | Min. | Тур.        | Max.    | Unit     |
|----------------------|---|--|------|-------------|---------|----------|
| V <sub>BR(CES)</sub> | Collector-Emitter<br>Breakdown Voltage                | I <sub>C</sub> = 1 mA, V <sub>GE</sub> = 0   | 600  |             |         | V        |
| I <sub>CES</sub>     | Collector cut-off Current (V <sub>GE</sub> = 0)       | $V_{CE}$ = Max Rating, $T_{C}$ = 25 °C $V_{CE}$ = Max Rating, $T_{C}$ = 125 °C                                     |      |             | 10<br>1 | μA<br>mA |
| I <sub>GES</sub>     | Gate-Emitter Leakage<br>Current (V <sub>CE</sub> = 0) | V <sub>GE</sub> = ± 20V , V <sub>CE</sub> = 0  |      |             | ±100    | nA       |
| V <sub>GE(th)</sub>  | Gate Threshold Voltage                                | $V_{CE} = V_{GE}, I_{C} = 250 \mu A$   | 3.75 |             | 5.75    | V        |
| V <sub>CE(sat)</sub> | Collector-Emitter<br>Saturation Voltage               | V <sub>GE</sub> = 15V, I <sub>C</sub> = 7 A<br>V <sub>GE</sub> = 15V, I <sub>C</sub> = 7 A, T <sub>C</sub> = 125°C |      | 1.85<br>1.7 | 2.5     | V<br>V   |

<sup>(#)</sup> Calculated according to the iterative formula:

$$I_{C}(T_{C}) = \frac{T_{JMAX} - T_{C}}{R_{THJ-C} \times V_{CESAT(MAX)}(T_{C}, I_{C})}$$

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#### **ELECTRICAL CHARACTERISTICS** (CONTINUED)

#### Table 6: Dynamic

| Symbol   | Parameter   | Test Conditions  | Min. | Тур.          | Max. | Unit           |
|--|---|--|------|---------------|------|----------------|
| g <sub>fs</sub> (1)                                  | Forward Transconductance  | V <sub>CE</sub> = 15 V , I <sub>C</sub> = 7 A  |      | 4.30          |      | S              |
| C <sub>ies</sub>                                     | Input Capacitance   | $V_{CE} = 25 \text{ V, f} = 1 \text{ MHz, } V_{GE} = 0$  |      | 720           |      | pF             |
| C <sub>oes</sub>                                     | Output Capacitance  |  |      | 81            |      | pF             |
| C <sub>res</sub>                                     | Reverse Transfer<br>Capacitance                                   |  |      | 17            |      | pF             |
| Q <sub>g</sub><br>Q <sub>ge</sub><br>Q <sub>gc</sub> | Total Gate Charge<br>Gate-Emitter Charge<br>Gate-Collector Charge | $V_{CE}$ = 390 V, $I_{C}$ = 7 A,<br>$V_{GE}$ = 15 V<br>(see Figure 21)                               |      | 35<br>7<br>16 | 48   | nC<br>nC<br>nC |
| I <sub>CL</sub>                                      | Turn-Off SOA Minimum<br>Current                                   | $V_{clamp} = 480 \text{ V}$ , $Tj = 150^{\circ}\text{C}$ $R_G = 10 \Omega$ , $V_{GE} = 15 \text{ V}$ | 50   |               |      | A              |

<sup>(1)</sup> Pulsed: Pulse duration= 300 µs, duty cycle 1.5%

#### Table 7: Switching On

| Sym                            | Symbol Parameter |  | Test Conditions   | Min. | Тур.                | Max. | Unit             |
|--------------------------------|------------------|--|---|------|---------------------|------|------------------|
| t <sub>d(c</sub><br>t<br>(di/c | r                | Turn-on Delay Time<br>Current Rise Time<br>Turn-on Current Slope | $V_{CC}$ = 390 V, $I_{C}$ = 7 A<br>R <sub>G</sub> = 10 $\Omega$ , $V_{GE}$ = 15V, Tj= 25°C<br>(see Figure 18)                     |      | 18.5<br>8.5<br>1060 |      | ns<br>ns<br>A/µs |
| t <sub>d(c</sub><br>t<br>(di/c | r                | Turn-on Delay Time<br>Current Rise Time<br>Turn-on Current Slope | $V_{CC} = 390 \text{ V, } I_{C} = 7 \text{ A}$<br>R <sub>G</sub> = 10 $\Omega$ , V <sub>GE</sub> = 15V, Tj= 125°C (see Figure 19) |      | 18.5<br>7<br>1000   |      | ns<br>ns<br>A/µs |

### **Table 8: Switching Off**

| Symbol         | Parameter             | Test Conditions                                      | Min. | Тур. | Max. | Unit |
|----------------|-----------------------|--|------|------|------|------|
| $t_r(V_{off})$ | Off Voltage Rise Time | $V_{cc} = 390 \text{ V, } I_C = 7 \text{ A,}$        |      | 27   |      | ns   |
| $t_{d(off)}$   | Turn-off Delay Time   | $R_G = 10 \Omega$ , $V_{GE} = 15 V$<br>$T_J = 25 °C$ |      | 72   |      | ns   |
| t <sub>f</sub> | Current Fall Time     | (see Figure 19)                                      |      | 60   |      | ns   |
| $t_r(V_{off})$ | Off Voltage Rise Time | $V_{CC} = 390 \text{ V, } I_{C} = 7 \text{ A,}$      |      | 56   |      | ns   |
| $t_{d(off)}$   | Turn-off Delay Time   | $R_G = 10 \Omega$ , $V_{GE} = 15 V$<br>Ti = 125 °C   |      | 116  |      | ns   |
| $t_f$          | Current Fall Time     | (see Figure 19)                                      |      | 105  |      | ns   |

#### Table 9: Switching Energy

| Ī | Symbol Parameter                                   |   | Test Conditions  | Min. | Тур.              | Max               | Unit           |
|---|--|---|--|------|-------------------|-------------------|----------------|
|   | Eon (2)<br>E <sub>off</sub> (3)<br>E <sub>ts</sub> | Turn-on Switching Losses Turn-off Switching Loss Total Switching Loss       | $V_{CC} = 390 \text{ V, } I_{C} = 7 \text{ A}$ $R_{G} = 10 \Omega$ , $V_{GE} = 15 \text{ V, } T_{j} = 25 ^{\circ}\text{C}$ (see Figure 19) |      | 95<br>115<br>210  | 125<br>150<br>275 | µJ<br>µJ<br>µJ |
|   | Eon (2)<br>E <sub>off</sub> (3)<br>E <sub>ts</sub> | Turn-on Switching Losses<br>Turn-off Switching Loss<br>Total Switching Loss | $V_{CC} = 390 \text{ V, } I_{C} = 7 \text{ A}$ $R_{G} = 10 \Omega, V_{GE} = 15 \text{V, Tj} = 125 ^{\circ}\text{C}$ (see Figure 19)        |      | 140<br>215<br>355 |                   | µJ<br>µJ<br>µJ |

<sup>2)</sup> Eon is the turn-on losses when a typical diode is used in the test circuit in figure 2. If the IGBT is offered in a package with a co-pack diode, the co-pack diode is used as external diode. IGBTs & DIODE are at the same temperature (25°C and 125°C) (3)Turn-off losses include also the tail of the collector current.

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Figure 3: Output Characteristics

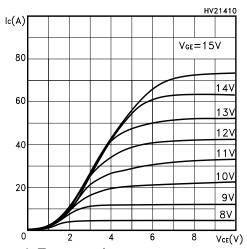


Figure 4: Transconductance

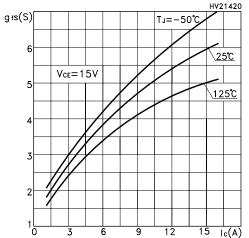


Figure 5: Collector-Emitter On Voltage vs Collector Current

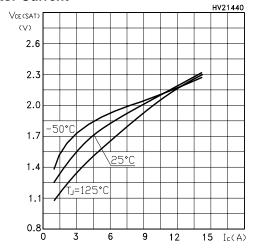


Figure 6: Transfer Characteristics

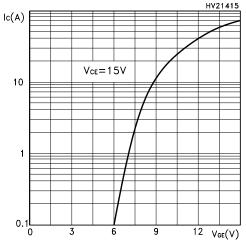


Figure 7: Collector-Emitter On Voltage vs Temperature

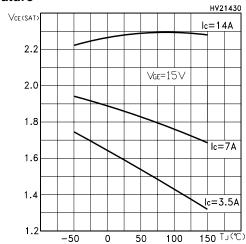
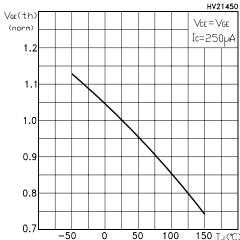


Figure 8: Normalized Gate Threshold vs Temperature



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Figure 9: Normalized Breakdown Voltage vs Temperature

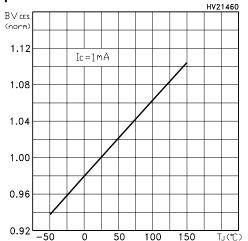


Figure 10: Capacitance Variations

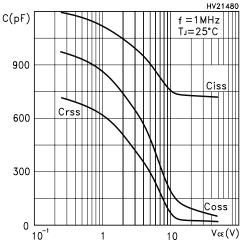


Figure 11: Total Switching Losses vs Gate Resistance

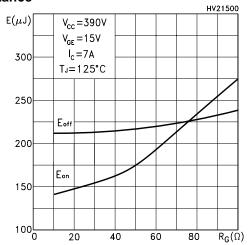


Figure 12: Gate Charge vs Gate-Emitter Voltage

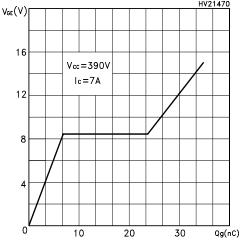


Figure 13: Total Switching Losses vs Temperature

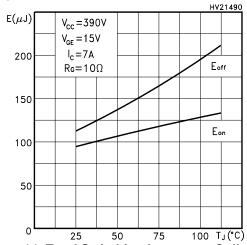


Figure 14: Total Switching Losses vs Collector Current

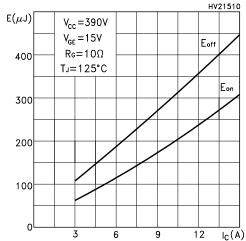


Figure 15: Thermal Impedance for TO-220

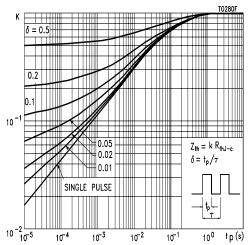


Figure 16: Thermal Impedance for DPAK

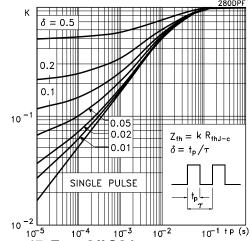


Figure 17: Turn-Off SOA

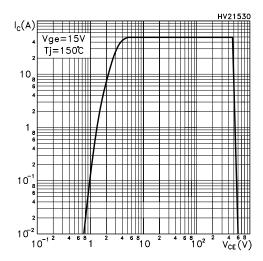
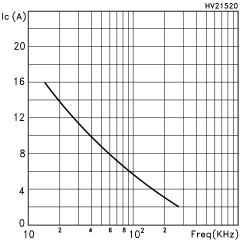


Figure 18: Ic vs Frequency



For a fast IGBT suitable for high frequency applications, the typical collector current vs. maximum operating frequency curve is reported. That frequency is defined as follows:

$$f_{MAX} = (P_D - P_C) / (E_{ON} + E_{OFF})$$

1) The maximum power dissipation is limited by maximum junction to case thermal resistance:

$$P_D = \Delta T / R_{THJ-C}$$

considering  $\Delta T = T_J - T_C = 125 \,^{\circ}\text{C} - 75 \,^{\circ}\text{C} = 50 \,^{\circ}\text{C}$ 

2) The conduction losses are:

$$P_C = I_C * V_{CE(SAT)} * \delta$$

with 50% of duty cycle,  $V_{CESAT}$  typical value @125°C.

3) Power dissipation during ON & OFF commutations is due to the switching frequency:

$$P_{SW} = (E_{ON} + E_{OFF}) * freq.$$

4) Typical values @  $125^{\circ}$ C for switching losses are used (test conditions:  $V_{CE} = 390$ V,  $V_{GE} = 15$ V,  $R_{G} = 3.3$  Ohm). Furthermore, diode recovery energy is included in the  $E_{ON}$  (see note 2), while the tail of the collector current is included in the  $E_{OFF}$  measurements (see note 3).

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Figure 19: Test Circuit for Inductive Load Switching

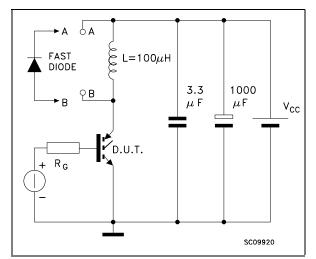


Figure 20: Switching Waveforms

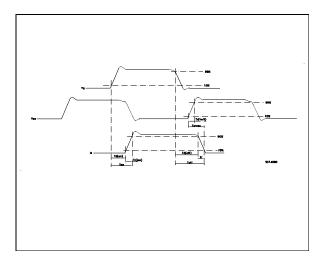
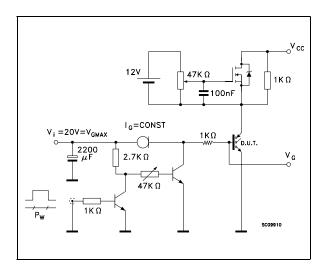
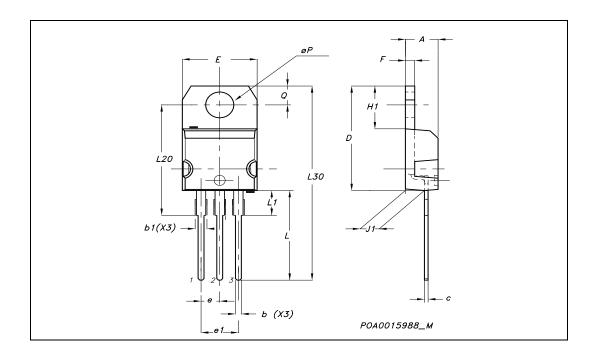


Figure 21: Gate Charge Test Circuit



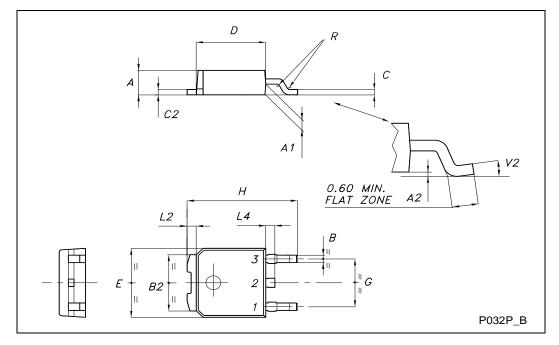
## **TO-220 MECHANICAL DATA**

| DIM  | mm.   |       |       |       | inch  |       |
|------|-------|-------|-------|-------|-------|-------|
| DIM. | MIN.  | TYP   | MAX.  | MIN.  | TYP.  | MAX.  |
| Α    | 4.40  |       | 4.60  | 0.173 |       | 0.181 |
| b    | 0.61  |       | 0.88  | 0.024 |       | 0.034 |
| b1   | 1.15  |       | 1.70  | 0.045 |       | 0.066 |
| С    | 0.49  |       | 0.70  | 0.019 |       | 0.027 |
| D    | 15.25 |       | 15.75 | 0.60  |       | 0.620 |
| E    | 10    |       | 10.40 | 0.393 |       | 0.409 |
| е    | 2.40  |       | 2.70  | 0.094 |       | 0.106 |
| e1   | 4.95  |       | 5.15  | 0.194 |       | 0.202 |
| F    | 1.23  |       | 1.32  | 0.048 |       | 0.052 |
| H1   | 6.20  |       | 6.60  | 0.244 |       | 0.256 |
| J1   | 2.40  |       | 2.72  | 0.094 |       | 0.107 |
| L    | 13    |       | 14    | 0.511 |       | 0.551 |
| L1   | 3.50  |       | 3.93  | 0.137 |       | 0.154 |
| L20  |       | 16.40 |       |       | 0.645 |       |
| L30  |       | 28.90 |       |       | 1.137 |       |
| øΡ   | 3.75  |       | 3.85  | 0.147 |       | 0.151 |
| Q    | 2.65  |       | 2.95  | 0.104 |       | 0.116 |



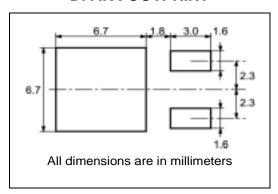
## **TO-252 (DPAK) MECHANICAL DATA**

| DIM.  |      | mm   |       |       | inch  |       |
|-------|------|------|-------|-------|-------|-------|
| Diwi. | MIN. | TYP. | MAX.  | MIN.  | TYP.  | MAX.  |
| Α     | 2.20 |      | 2.40  | 0.087 |       | 0.094 |
| A1    | 0.90 |      | 1.10  | 0.035 |       | 0.043 |
| A2    | 0.03 |      | 0.23  | 0.001 |       | 0.009 |
| В     | 0.64 |      | 0.90  | 0.025 |       | 0.035 |
| B2    | 5.20 |      | 5.40  | 0.204 |       | 0.213 |
| С     | 0.45 |      | 0.60  | 0.018 |       | 0.024 |
| C2    | 0.48 |      | 0.60  | 0.019 |       | 0.024 |
| D     | 6.00 |      | 6.20  | 0.236 |       | 0.244 |
| E     | 6.40 |      | 6.60  | 0.252 |       | 0.260 |
| G     | 4.40 |      | 4.60  | 0.173 |       | 0.181 |
| Н     | 9.35 |      | 10.10 | 0.368 |       | 0.398 |
| L2    |      | 0.8  |       |       | 0.031 |       |
| L4    | 0.60 |      | 1.00  | 0.024 |       | 0.039 |
| V2    | 0°   |      | 8°    | 0°    |       | 0°    |

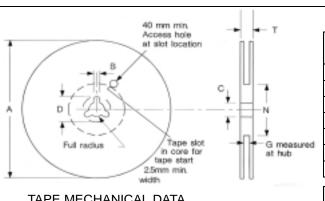


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#### **DPAK FOOTPRINT**



#### TAPE AND REEL SHIPMENT



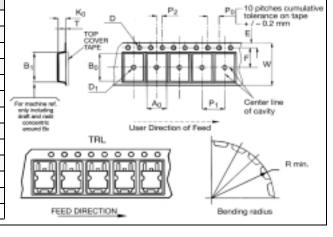
#### REEL MECHANICAL DATA

| DIM.   | m    | m    | in    | ch     |
|--------|------|------|-------|--------|
| Dilvi. | MIN. | MAX. | MIN.  | MAX.   |
| Α      |      | 330  |       | 12.992 |
| В      | 1.5  |      | 0.059 |        |
| С      | 12.8 | 13.2 | 0.504 | 0.520  |
| D      | 20.2 |      | 0.795 |        |
| G      | 16.4 | 18.4 | 0.645 | 0.724  |
| N      | 50   |      | 1.968 |        |
| Т      |      | 22.4 |       | 0.881  |

#### TAPE MECHANICAL DATA

| DIM. | mm   |      | inch  |       |
|------|------|------|-------|-------|
|      | MIN. | MAX. | MIN.  | MAX.  |
| A0   | 6.8  | 7    | 0.267 | 0.275 |
| B0   | 10.4 | 10.6 | 0.409 | 0.417 |
| B1   |      | 12.1 |       | 0.476 |
| D    | 1.5  | 1.6  | 0.059 | 0.063 |
| D1   | 1.5  |      | 0.059 |       |
| E    | 1.65 | 1.85 | 0.065 | 0.073 |
| F    | 7.4  | 7.6  | 0.291 | 0.299 |
| K0   | 2.55 | 2.75 | 0.100 | 0.108 |
| P0   | 3.9  | 4.1  | 0.153 | 0.161 |
| P1   | 7.9  | 8.1  | 0.311 | 0.319 |
| P2   | 1.9  | 2.1  | 0.075 | 0.082 |
| R    | 40   |      | 1.574 |       |
| W    | 15.7 | 16.3 | 0.618 | 0.641 |

**BULK QTY BASE QTY** 2500 2500



## **Table 10: Revision History**

| Date        | Revision | Description of Changes |
|-------------|----------|------------------------|
| 20-Aug-2004 | 1        | New datasheet          |
| 09-Jun-2005 | 2        | Modified title         |

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